

# GFC X | Gas Flow Controller

### PRECISE CONTROL. UNPARALLELED PERFORMANCE.

The GFC X, the latest generation in Pivotal's high-flow product line, features a pressure-based flow controller with a position control valve, allowing for precise control. We offer one of the industry's widest ranges of accuracy, making it ideal for various applications, including deposition processes. The GFC X paves the way for the future of gas flow control by offering an order of magnitude improvement on key flow metrics and enabling advanced wafer-manufacturing processes. In addition, the GFC X offers a range of accuracy from 5% to 100% of full scale, surpassing many competitors.

#### Benefits of GFC-X

- Significantly reduces downtime
- Wide flow range up to 50 slm
- Industry's best flow accuracy for entire flow range
- Advanced flow monitoring/self-diagnosis

#### **Key Features**

- Self-calibrating
- Innovative control technology
- Unaffected by variations in the upstream or downstream pressure or temperature
- No fixed orifice



## GFC-X Specifications (GFC-X 5L, GFC- X 20L, GFC-X 50L)

| PERFORMANCE          | Flow Range (N2 Equivalent)       | 100 sccm - 50000 sccm (3 bin sizes to cover the range)   |
|----------------------|----------------------------------|--|
|                      | Flow Accuracy                    | ±1% of setpoint for 5%-100% full scale: 0.5 slm - 5 slm (GFC X5L), 2.0 slm - 20 slm (GFC X20L), 5.0 slm to 50 slm (GFC X50L) ±0.05% of full scale for flows 0.5% to 5% full scale: 0.1 slm - 0.5 slm (GFC X5L), 0.4 slm - 2.0 slm (GFC X20L), 1.0 slm - 5.0 slm (GFC X50L) |
|                      | Repeatability                    | $\pm 0.25\%$ of setpoint for $10\%$ - $100\%$ full scale   |
|                      | Settling Time                    | $\leq$ 150 ms $5\%$ - 100% full scale, $\leq$ 200 ms $0.05\%$ - $5\%$ full scale   |
|                      | Leak Integrity                   | ≤ 1E-9 atm•cc/sec (He)   |
|                      | Leak By Rate                     | ≤ 0.05% full scale   |
| OPERATING CONDITIONS | Supply Pressure                  | Standard: 276 - 448 kPaG (40 - 65 psig)  |
|                      | Downstream Pressure              | Vacuum to 101 kPa (0 - 760 Torr)   |
|                      | Design Pressure (Burst Pressure) | 2.07 MPaG (300 psig)   |
|                      | Operating Temperature            | 15°C - 50°C  |
| MATERIALS            | Wetted Surface                   | 316 SS per Semi F20  |
|                      | Surface Finish                   | 5 μin average Ra   |
|                      | Seals                            | Metal  |
| ELECTRICAL           | ECAT                             | +24VDC   |
|                      | DeviceNet                        | 11 – 24 VDC, 5 W; In-rush current <200mA   |
|                      | Analog and RS-485                | ±15 VDC, 150 mA  |